

101-00405-**

SD Conn. , Stand-off = 1.8mm



MATERIAL

HSG	: HIGH TEMPERATURE THERMOPLASTIC
CONTACT	: COPPER ALLOY
SHELL	: COPPER ALLOY

RATING

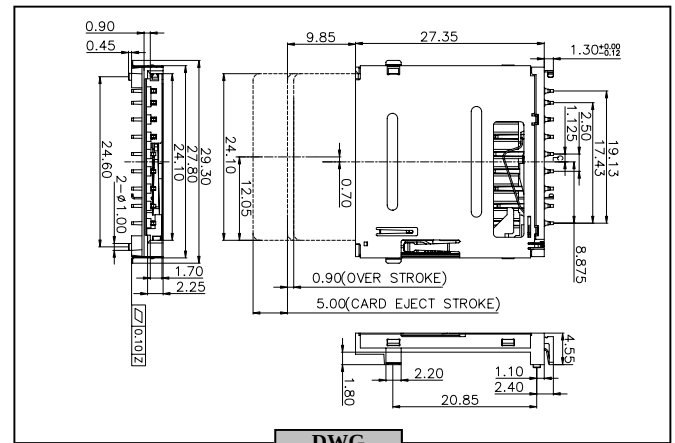
CURRENT RATING : 0.5 Amp
RATED VOLTAGE : 250 VAC

ELECTRICAL

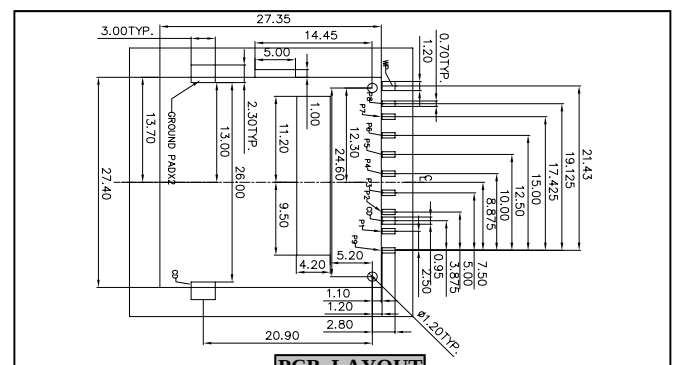
CONTACT RESISTANCE : 100 mΩ Max.
INSULATION RESISTANCE : 1000 MΩ Max.
DIELECTRIC WITHSTANDING VOLTAGE : 500 VAC/RMS

OPERATING TEMPERATURE

-20°C ~ + 65°C



DWG



PCB LAYOUT

CIRCUIT: WP GROUND CD GROUND WITHOUT CARD	WP GROUND CD GROUND CARD INSERTED WRITE PROTECT : LOCK	WP GROUND CD GROUND CARD INSERTED WRITE PROTECT : UNLOCK
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101-00313-**

SD Conn. , Stand-off = 0mm



MATERIAL

HSG : HIGH TEMPERATURE THERMOPLASTIC
SLIDE : PA 46
CONTACT : COPPER ALLOY
SHELL : COPPER ALLOY

RATING

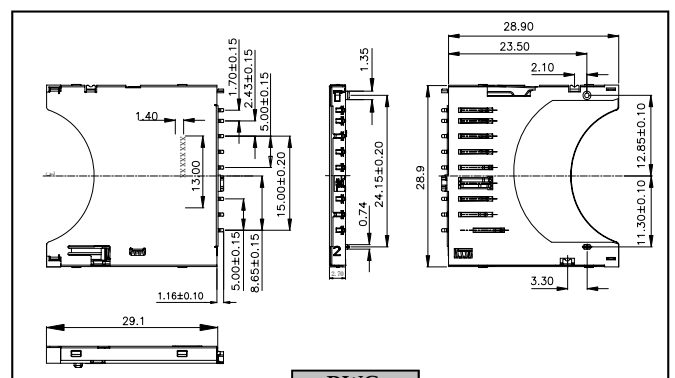
CURRENT RATING : 0.5 A mp
RATED VOLTAGE : 250 VAC

ELECTRICAL

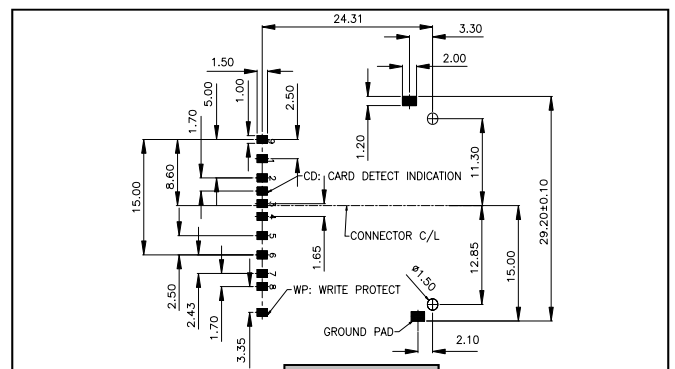
CONTACT RESISTANCE : 100 mΩ Max.
INSULATION RESISTANCE : 1000 MΩ Max.
DIELECTRIC WITHSTANDING VOLTAGE : 500 VAC/RMS

OPERATING TEMPERATURE

-20°C ~ + 65°C



DWG



PCB LAYOUT

CIRCUIT: WITHOUT CARD	CARD INSERTED WRITF PROTCTJ : LOCK	CARD INSERTED WRITF PROTCTJ : UNI LOCK
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101-00565-**

SD+MMC+MMC 4.0 Conn



MATERIAL

HSG : HIGH TEMPERATURE THERMOPLASTIC
CONTACT : COPPER ALLOY
SHELL : COPPER ALLOY

RATING

CURRENT RATING : 0.5 Amp
RATED VOLTAGE : 250 VAC

ELECTRICAL

CONTACT RESISTANCE : 100 mΩ Max.
INSULATION RESISTANCE : 1000 MΩ Max.
DIELECTRIC WITHSTANDING VOLTAGE : 500 VAC/RMS

OPERATING TEMPERATURE

-20°C ~ +65°C

101-00577-**

SD +MMC Connector, Manual Type



MATERIAL

HSG : HIGH TEMPERATURE THERMOPLASTIC
CONTACT : COPPER ALLOY
SHELL : COPPER ALLOY

RATING

CURRENT RATING : 0.5 Amp
RATED VOLTAGE : 250 VAC

ELECTRICAL

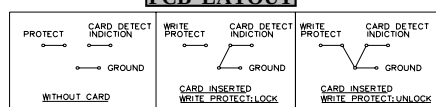
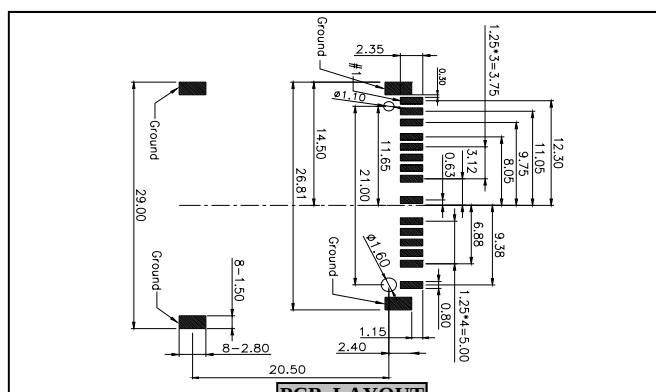
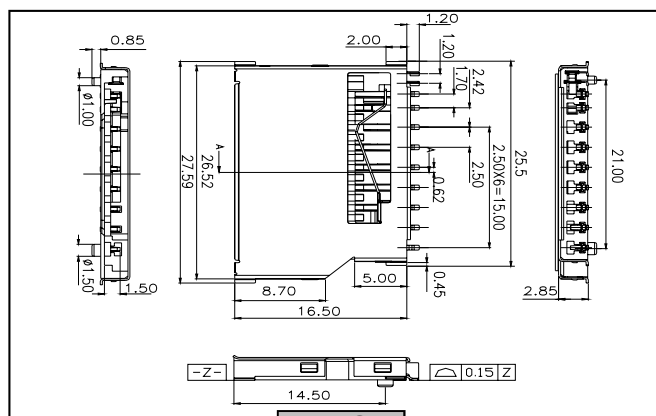
CONTACT RESISTANCE : 100 mΩ Max.
INSULATION RESISTANCE : 1000 MΩ Max.
DIELECTRIC WITHSTANDING VOLTAGE : 500 VAC/RMS

OPERATING TEMPERATURE

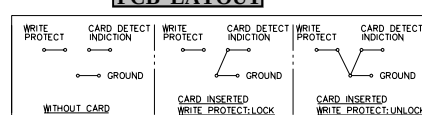
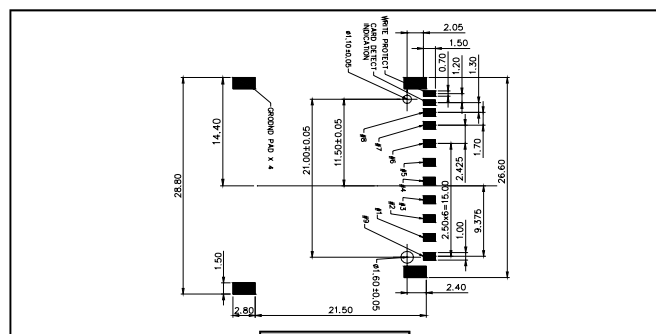
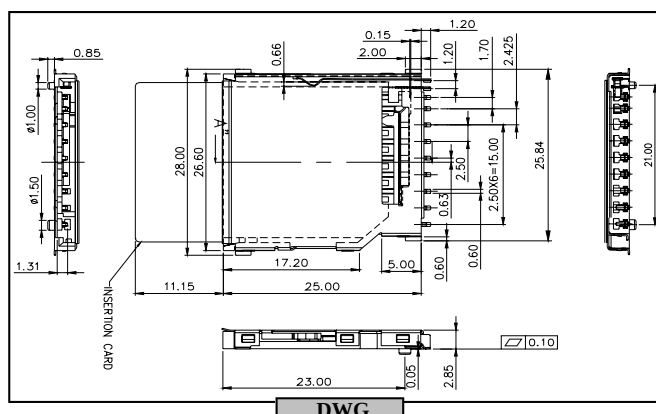
-20°C ~ +65°C

Single Card Socket

Push-Push Type



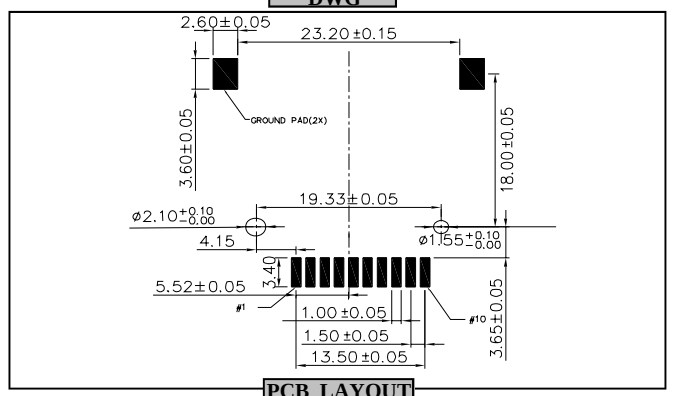
Push -Pull Type



SD Conn., Manual , Short body

Push in-Pull out Type

MS Conn, Reverse Type



101-00002-**

SIM+ XD Conn P-P Combo Connector



MATERIAL

HSG : HIGH TEMPERATURE THERMOPLASTIC
CONTACT : COPPER ALLOY
SHELL : COPPER ALLOY

RATING

CURRENT RATING : 1 Amp
RATED VOLTAGE : 100 VAC

ELECTRICAL

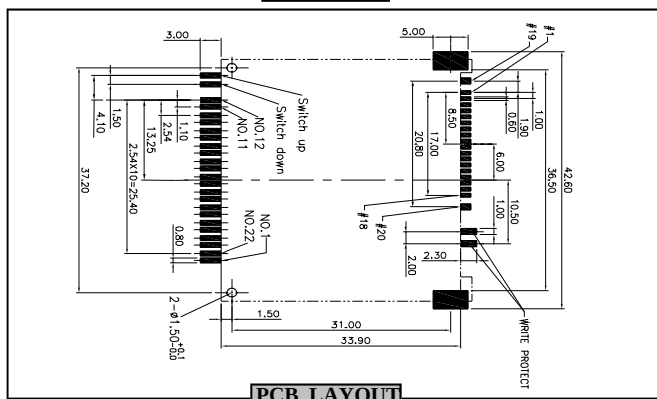
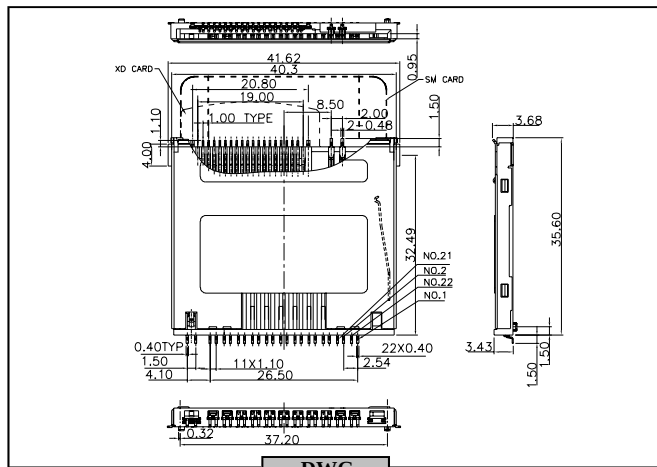
CONTACT RESISTANCE : 40 mΩ Max.
INSULATION RESISTANCE : 1000 MΩ Max.
DIELECTRIC WITHSTANDING VOLTAGE : 250 VAC/RMS

OPERATING TEMPERATURE

-20°C ~ + 65°C

Single Card Socket

SIM : Push in -Pull out
XD: Push in - Push out



101-00158-**

XD Connector, Manual Type



MATERIAL

HSG : HIGH TEMPERATURE THERMOPLASTIC
CONTACT : COPPER ALLOY
SHELL : COPPER ALLOY

RATING

CURRENT RATING : 1 Amp
RATED VOLTAGE : 100 VAC

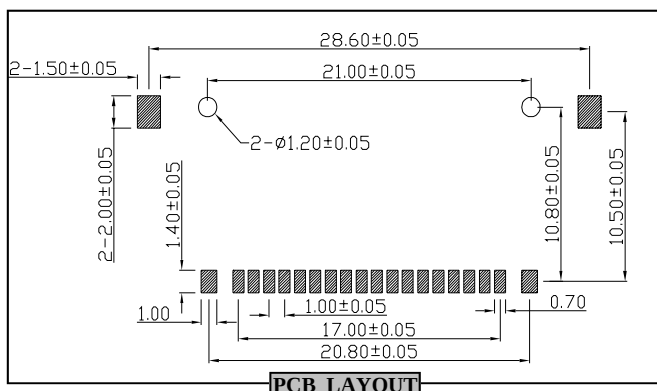
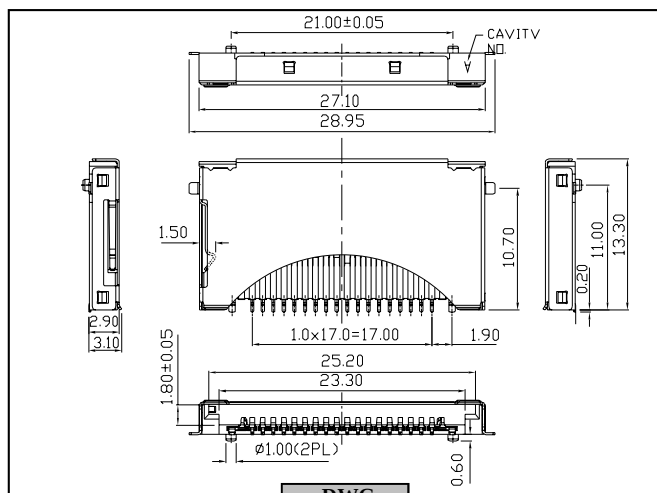
ELECTRICAL

CONTACT RESISTANCE : 40 mΩ Max.
INSULATION RESISTANCE : 1000 MΩ Max.
DIELECTRIC WITHSTANDING VOLTAGE : 250 VAC/RMS

OPERATING TEMPERATURE

-20°C ~ + 65°C

Push in -Pull out



101-00205-**

Reverse Type



MATERIAL

HSG	:	HIGH TEMPERATURE THERMOPLASTIC
CONTACT	:	COPPER ALLOY
SHELL	:	COPPER ALLOY

RATING

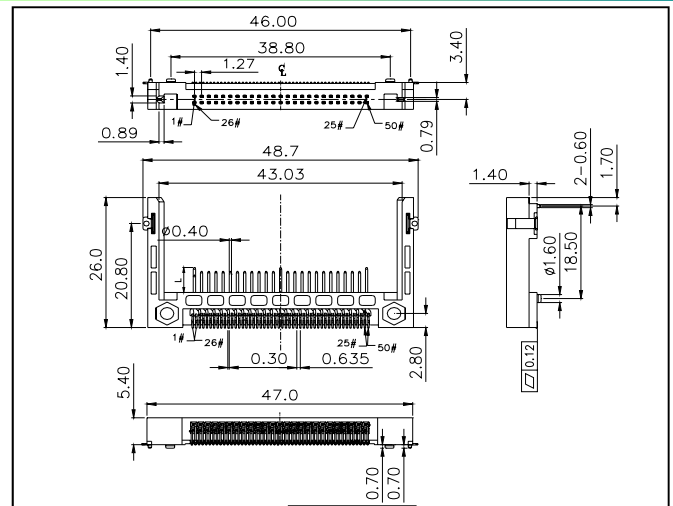
CURRENT RATING : 1 A mp
RATED VOLTAGE : 100 VAC

ELECTRICAL

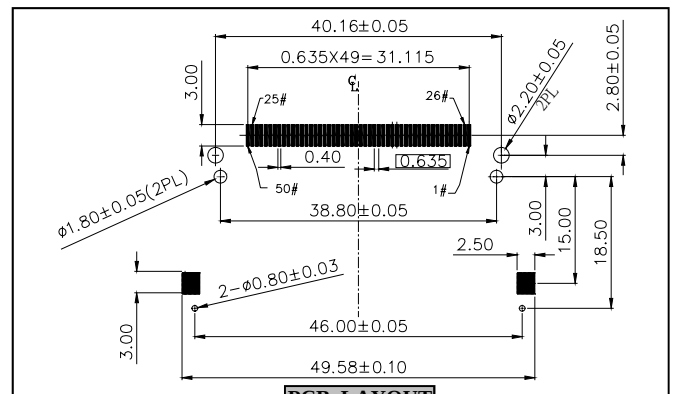
CONTACT RESISTANCE : 100 mΩ Max.
INSULATION RESISTANCE : 1000 MΩ Max.
DIELECTRIC WITHSTANDING VOLTAGE : 500 VAC/RMS

OPERATING TEMPERATURE

-20°C ~ + 60°C



DWG



PCB LAYOUT

101-00178-**

Normal Type



MATERIAL

HSG	:	HIGH TEMPERATURE THERMOPLASTIC
CONTACT	:	COPPER ALLOY
SHELL	:	COPPER ALLOY

RATING

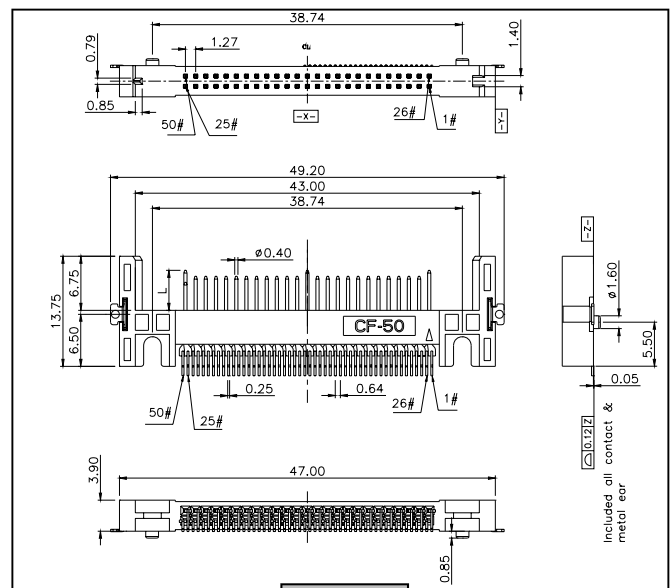
CURRENT RATING : 1 Amp
RATED VOLTAGE : 100 VAC

ELECTRICAL

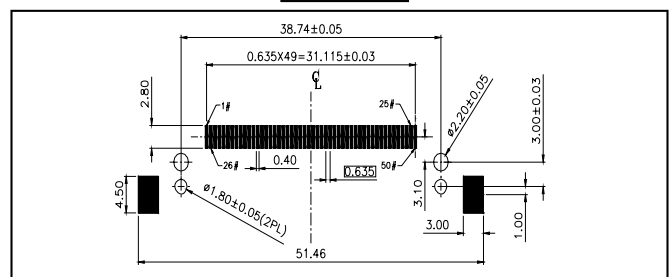
CONTACT RESISTANCE : 100 mΩ Max.
INSULATION RESISTANCE : 1000 MΩ Max.
DIELECTRIC WITHSTANDING VOLTAGE : 500 VAC/RMS

OPERATING TEMPERATURE

-20°C ~ +60°C



DWG



PCB LAYOUT

Single Card Socket

101-00140-**

CF, W/Shell, Stand-off=1.4mm

Reverse Type



MATERIAL

HSG : HIGH TEMPERATURE THERMOPLASTIC
CONTACT : COPPER ALLOY
SHELL : COPPER ALLOY

RATING

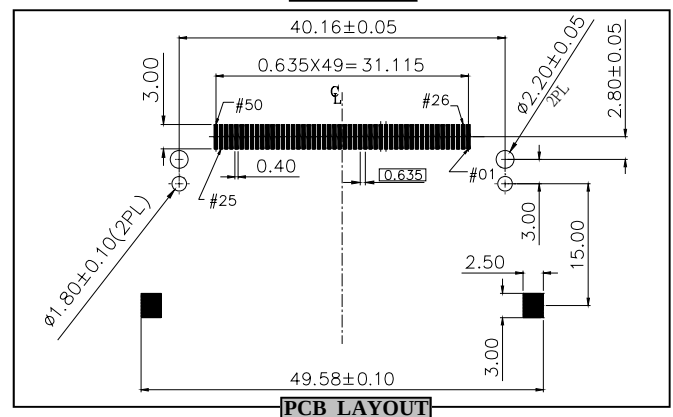
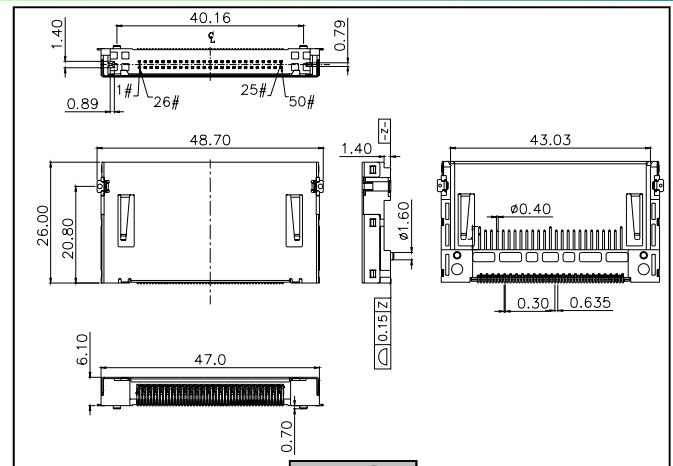
CURRENT RATING : 1 A AC/DC Max
RATED VOLTAGE : 100 VAC

ELECTRICAL

CONTACT RESISTANCE : 40 mΩ Max.
INSULATION RESISTANCE : 1000 MΩ Max.
DIELECTRIC WITHSTANDING VOLTAGE : 500 VAC/RMS

OPERATING TEMPERATURE

-20°C ~ +60°C



101-00265-**

CF, W/Shell

Reverse Type



MATERIAL

HSG : HIGH TEMPERATURE THERMOPLASTIC
CONTACT : COPPER ALLOY
SHELL : COPPER ALLOY

RATING

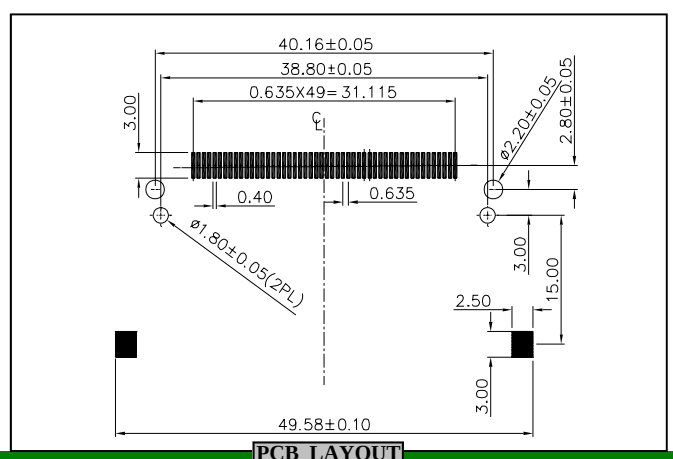
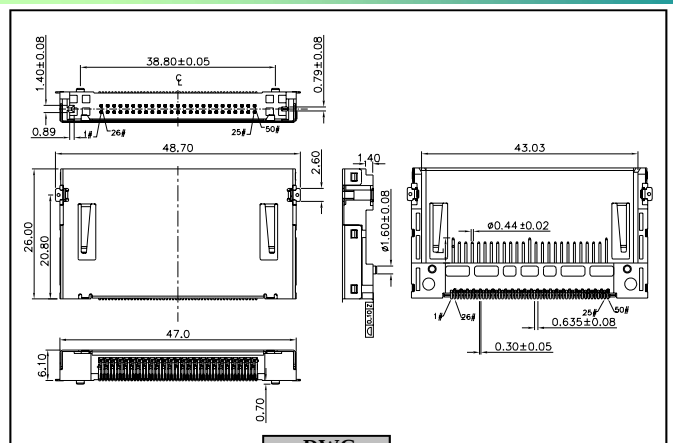
CURRENT RATING : 1 A AC/DC Max
RATED VOLTAGE : 100 VAC

ELECTRICAL

CONTACT RESISTANCE : 40 mΩ Max.
INSULATION RESISTANCE : 1000 MΩ Max.
DIELECTRIC WITHSTANDING VOLTAGE : 500 VAC/RMS

OPERATING TEMPERATURE

-20°C ~ +60°C



101-00578-**

3-in-1 Combo, Bottom mount



MATERIAL

HSG	:	HIGH TEMPERATURE THERMOPLASTIC
CONTACT	:	COPPER ALLOY
SHELL	:	COPPER ALLOY

RATING

CURRENT RATING : 0.5 A mp
RATED VOLTAGE : 500 VAC

ELECTRICAL

CONTACT RESISTANCE : 100 mΩ Max.
INSULATION RESISTANCE : 1000 MΩ Max.
DIELECTRIC WITHSTANDING VOLTAGE : 500 VAC/RMS

OPERATING TEMPERATURE

-20°C ~ + 60°C

101-00402-**

3-in-1 Combo, Top mount



MATERIAL

HSG	:	HIGH TEMPERATURE THERMOPLASTIC
CONTACT	:	COPPER ALLOY
SHELL	:	COPPER ALLOY

RATING

CURRENT RATING : 0.5 Amp
RATED VOLTAGE : 250 VAC

ELECTRICAL

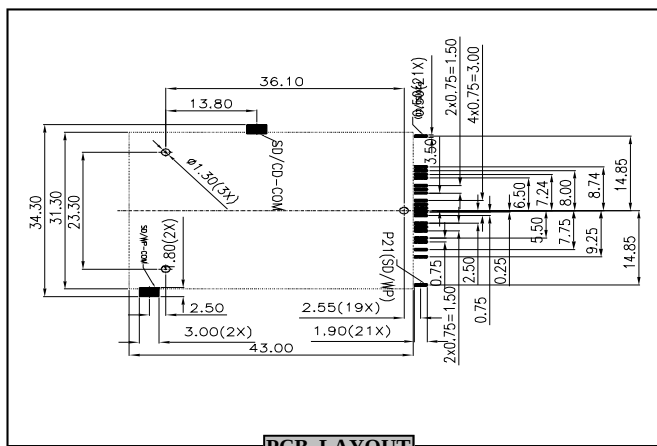
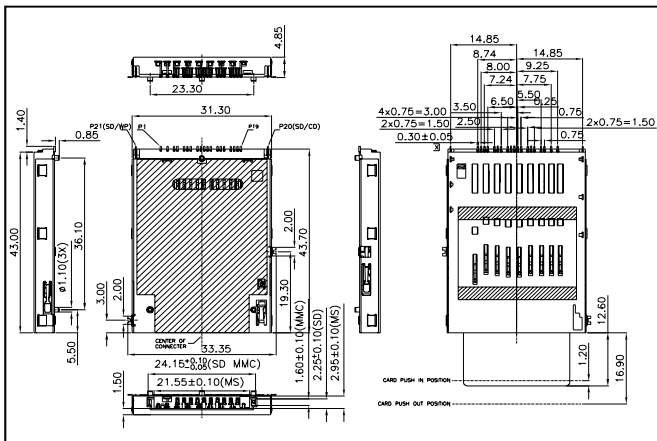
CONTACT RESISTANCE : 100 mΩ Max.
INSULATION RESISTANCE : 1000 MΩ Max.
DIELECTRIC WITHSTANDING VOLTAGE : 500 VAC/RMS

OPERATING TEMPERATURE

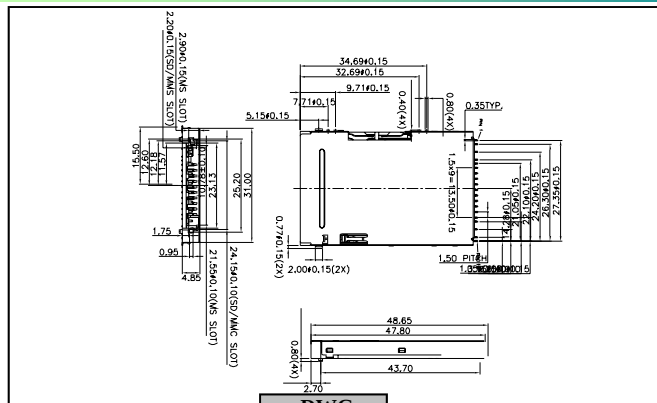
-20°C ~ + 60°C

Combo Card Socket

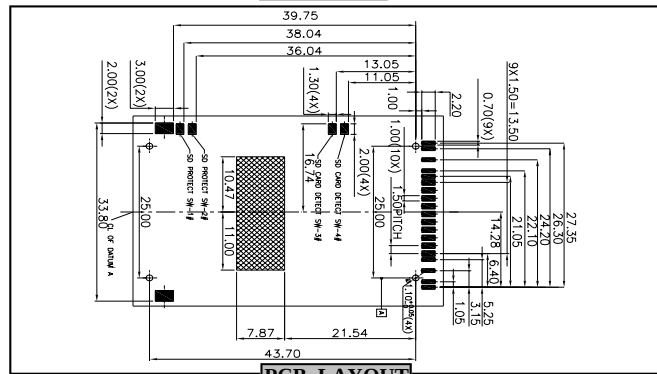
Push in- Push out



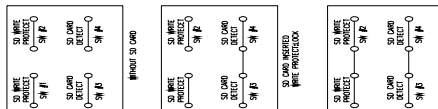
PCB LAYOUT



DWG



PCB LAYOUT



Combo Card Socket

4-in-1 Combo, Reverse, PCB Type



MATERIAL

HSG	:	HIGH TEMPERATURE THERMOPLASTIC
CONTACT	:	COPPER ALLOY
SHELL	:	COPPER ALLOY

RATING

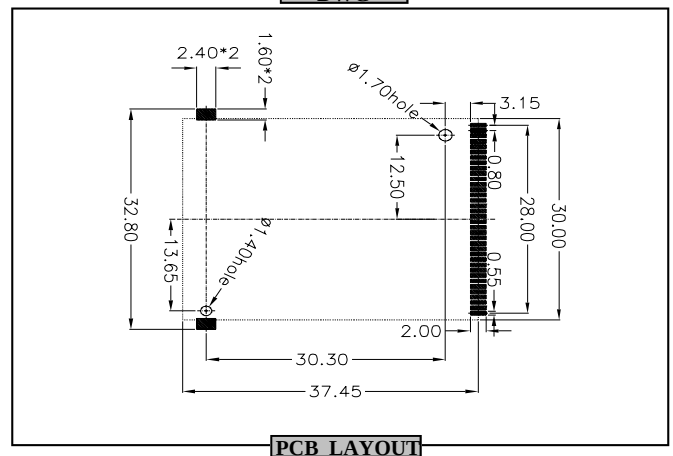
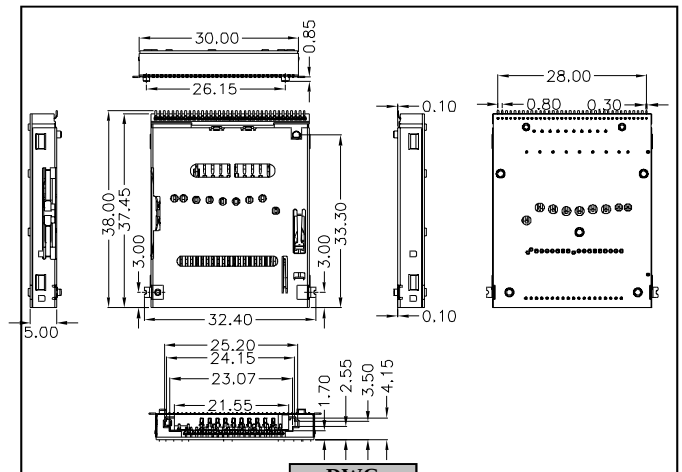
CURRENT RATING : 0.5 A mp
RATED VOLTAGE : 250 VAC

ELECTRICAL

CONTACT RESISTANCE : 100 mΩ Max.
INSULATION RESISTANCE : 1000 MΩ Max.
DIELECTRIC WITHSTANDING VOLTAGE : 500 VAC/RMS

OPERATING TEMPERATURE

-20°C ~ + 60°C



101-00414- / 101-00415-****

4-in-1 Combo, Top mount, PCB Type



MATERIAL

HSG	:	HIGH TEMPERATURE THERMOPLASTIC
CONTACT	:	COPPER ALLOY
SHELL	:	COPPER ALLOY

RATING

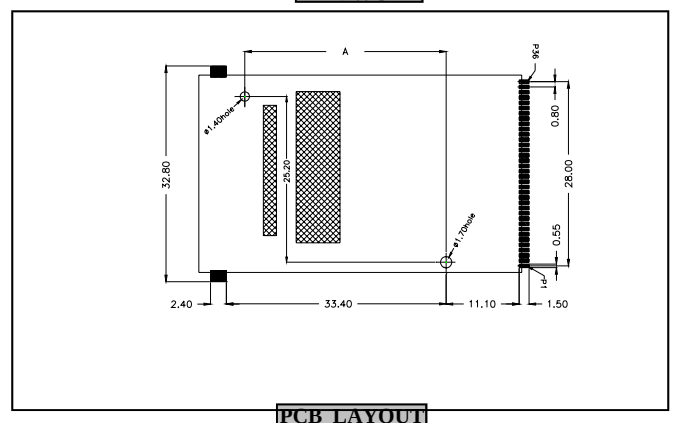
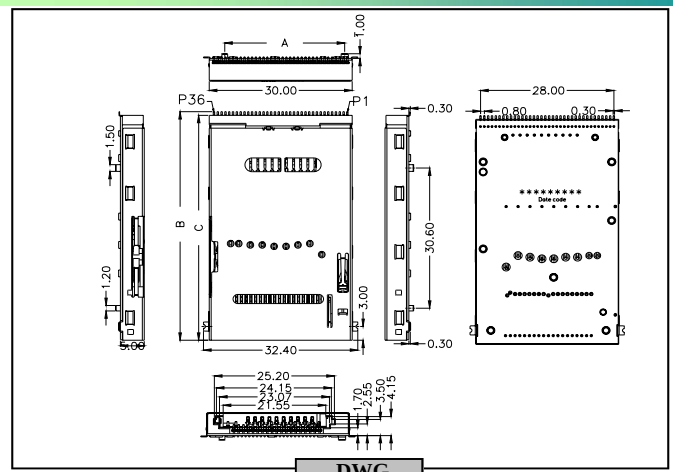
CURRENT RATING : 0.5 A mp
RATED VOLTAGE : 250 VAC

ELECTRICAL

CONTACT RESISTANCE : 100 mΩ Max.
INSULATION RESISTANCE : 1000 MΩ Max.
DIELECTRIC WITHSTANDING VOLTAGE : 500 VAC/RMS

OPERATING TEMPERATURE

-20°C ~ + 60°C



Combo Card Socket

101-00396-**

SD 6-in-1 Combo, Reverse Type

Push in-Pull out

MATERIAL

HSG : HIGH TEMPERATURE THERMOPLASTIC
CONTACT : COPPER ALLOY
SHELL : COPPER ALLOY

RATING

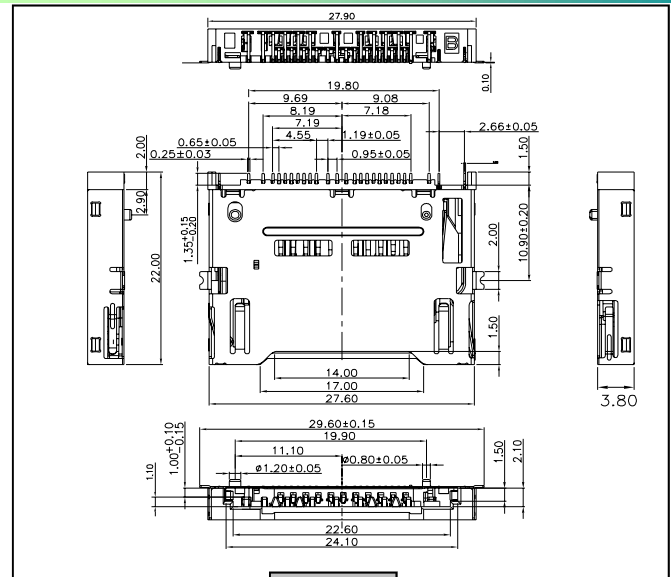
CURRENT RATING : 0.5 Amp
RATED VOLTAGE : 250 VAC

ELECTRICAL

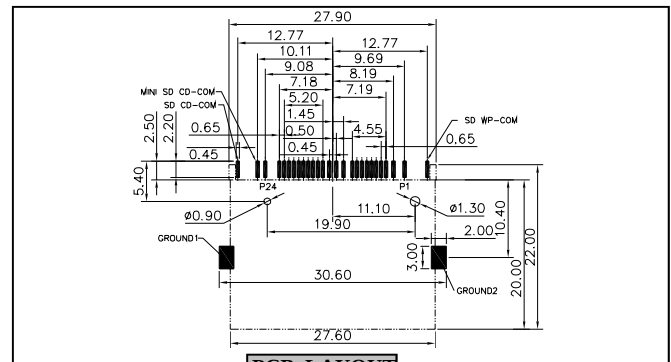
CONTACT RESISTANCE : 100 mΩ Max.
INSULATION RESISTANCE : 1000 MΩ Max.
DIELECTRIC WITHSTANDING VOLTAGE : 500 VAC/RMS

OPERATING TEMPERATURE

-20°C ~ +60°C



DWG



PCB LAYOUT

101-00395-**

SD 6-in-1 Combo, Top mount Type

Push in-Pull out



MATERIAL

HSG : HIGH TEMPERATURE THERMOPLASTIC
CONTACT : COPPER ALLOY
SHELL : COPPER ALLOY

RATING

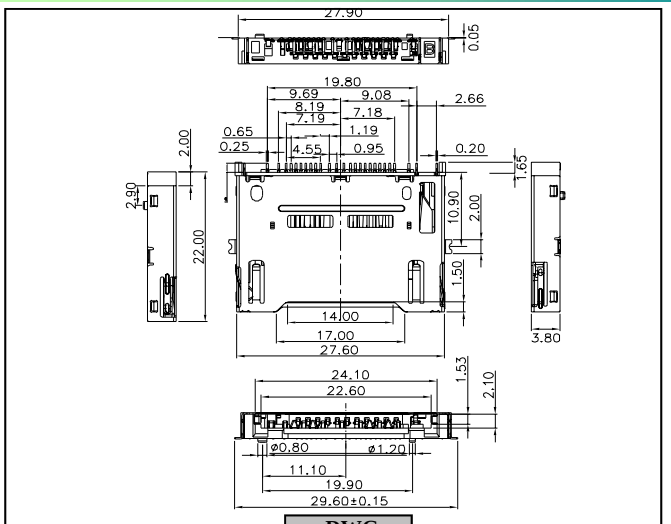
CURRENT RATING : 0.5 Amp
RATED VOLTAGE : 250 VAC

ELECTRICAL

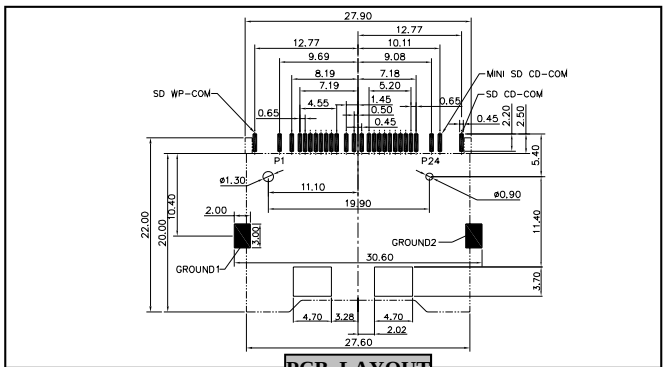
CONTACT RESISTANCE : 100 mΩ Max.
INSULATION RESISTANCE : 1000 MΩ Max.
DIELECTRIC WITHSTANDING VOLTAGE : 500 VAC/RMS

OPERATING TEMPERATURE

-20°C ~ +60°C



DWG



PCB LAYOUT

101-00139-**

Push in- Push out



RATING

ELECTRICAL

OPERATING TEMPERATURE

101-00236-**

Push in- Push out



RATING

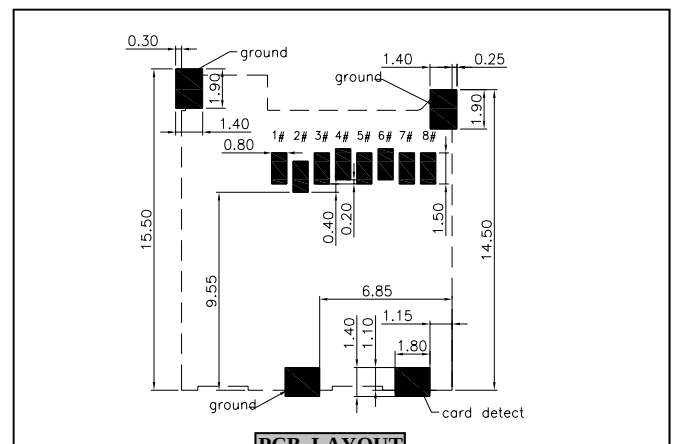
ELECTRICAL

OPERATING TEMPERATURE

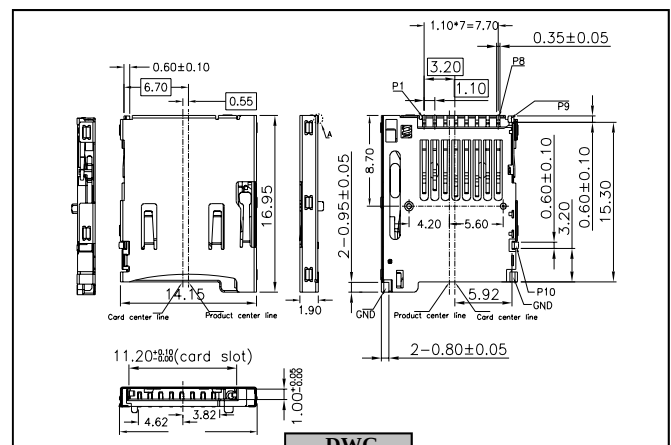
The technical drawings show the following dimensions:

- Top View:** Overall width 14.00, distance from left edge to first pin center 7.70±0.05, pin pitch 1.10±0.03, total pin length 0.98.
- Bottom View:** Overall height 15.20, distance from top edge to first pin center 1.30±0.08, chip area width 1.85, distance from right edge to last pin center 1.60.
- Side View:** Card thickness 1.0, contact pad height 0.60, distance from bottom edge to contact pads 10.75±0.10, distance between contact pads 1.20±0.03.

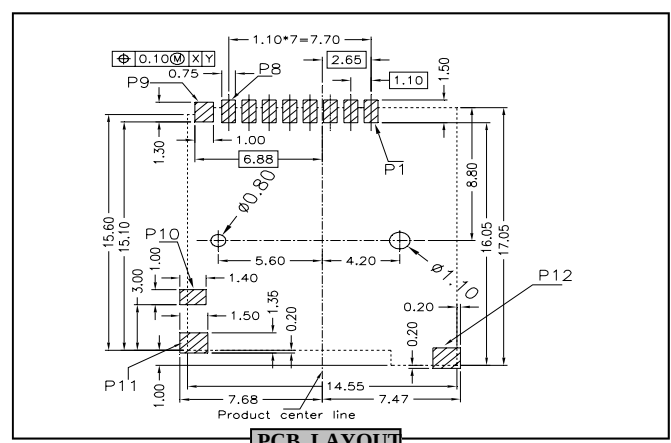
DWG



PCB LAYOUT



DWG



PCB LAYOUT

Micro-SD P/P ,W C/D Function



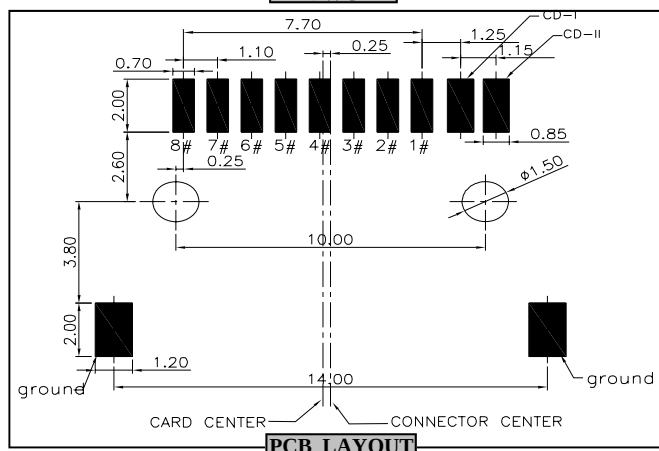
RATING

ELECTRICAL

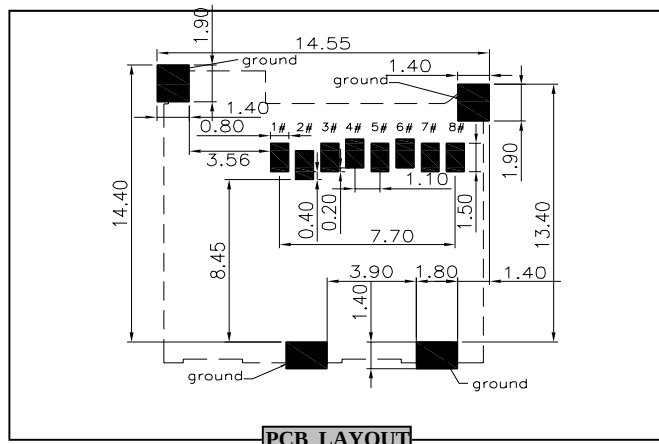
OPERATING TEMPERATURE

Miniature Card Socket

Push in-Pull out



Micro-SD CARD, Hinge Type



Miniature Card Socket

101-00349-**

Micro SD P/P , Normal Close

Push in- Push out



MATERIAL

HSG : HIGH TEMPERATURE THERMOPLASTIC
CONTACT : COPPER ALLOY
SHELL : COPPER ALLOY

RATING

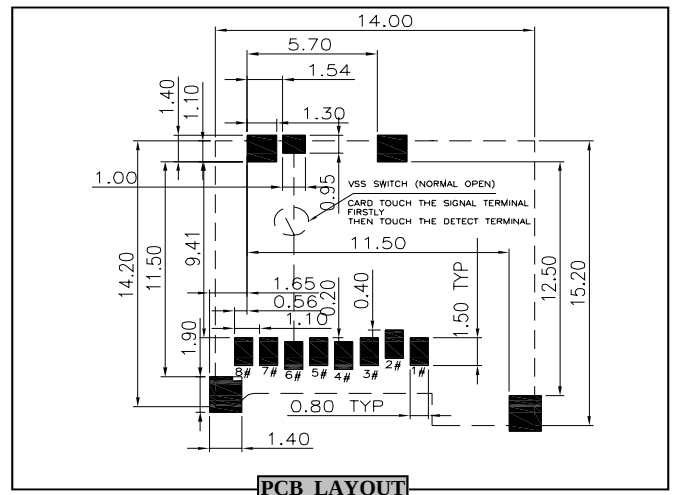
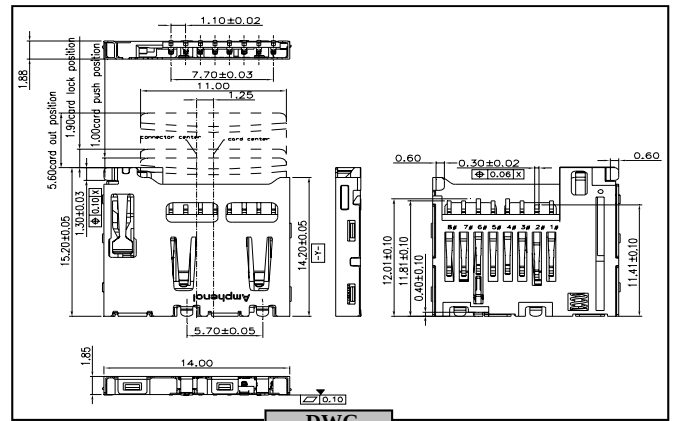
CURRENT RATING : 0.5 Amp
RATED VOLTAGE : 100 VAC

ELECTRICAL

CONTACT RESISTANCE : 100 mΩ Max.
INSULATION RESISTANCE : 1000 MΩ Max.
DIELECTRIC WITHSTANDING VOLTAGE : 500 VAC/RMS

OPERATING TEMPERATURE

-25°C ~ + 85°C



101-00112-**

Micro SD P-P , Hinge Type Conn. (8 pin)

Push in- Push out



MATERIAL

HSG : HIGH TEMPERATURE THERMOPLASTIC
CONTACT : COPPER ALLOY
SHELL : COPPER ALLOY

RATING

CURRENT RATING : 0.5 Amp
RATED VOLTAGE : 100 VAC

ELECTRICAL

CONTACT RESISTANCE : 100 mΩ Max.
INSULATION RESISTANCE : 1000 MΩ Max.
DIELECTRIC WITHSTANDING VOLTAGE : 500 VAC/RMS

OPERATING TEMPERATURE

-25°C ~ + 85°C

SIM + micro-SD P-P Combo



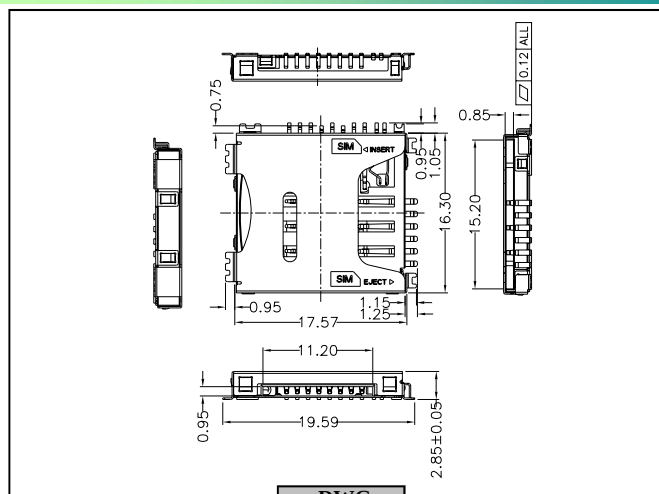
101-00318-**

SIM + micro-SD P-P Combo

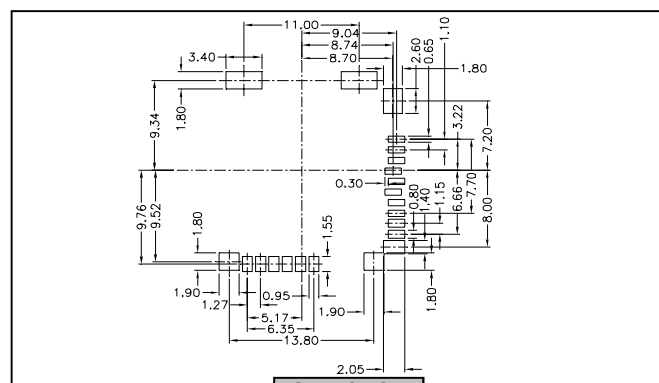


Miniature Card Socket

SIM : Push in -Pull out
microSD: Push in - Push out

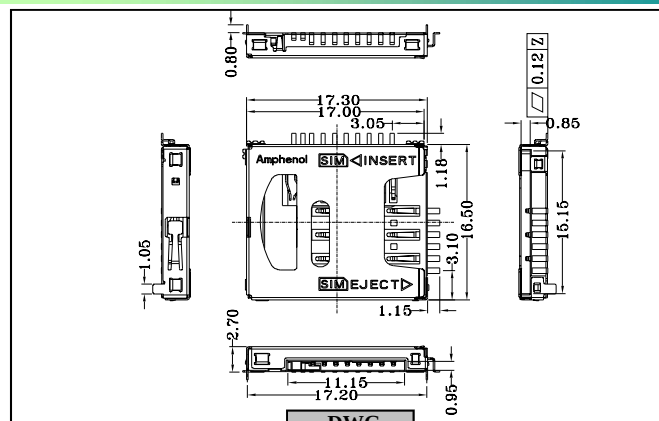


DWG

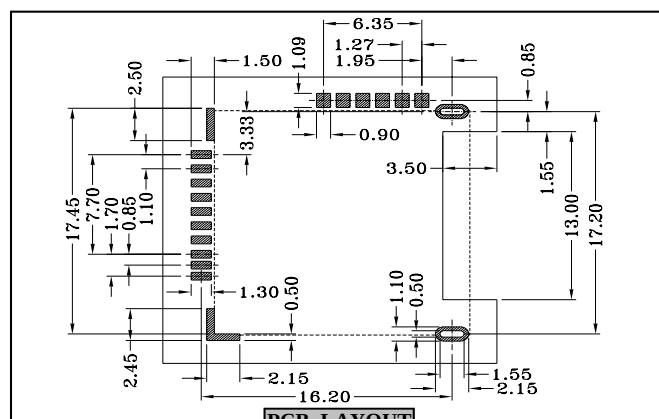


PCB LAYOUT

SIM : Push in -Pull out
microSD: Push in - Push out



DWG



PCB LAYOUT

101-00347-**

SIM + micro-SD P-P Combo, w / logo

MATERIAL

HSG : HIGH TEMPERATURE THERMOPLASTIC
CONTACT : COPPER ALLOY
SHELL : COPPER ALLOY

RATING

CURRENT RATING : 0.5 A AC/DC Max
RATED VOLTAGE : 100 VAC

ELECTRICAL

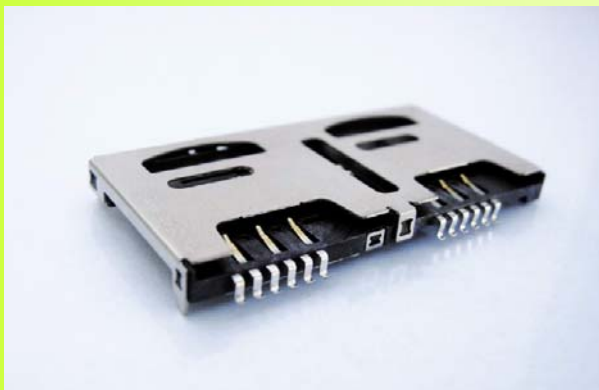
CONTACT RESISTANCE : 100 mΩ Max.
INSULATION RESISTANCE : 1000 MΩ Max.
DIELECTRIC WITHSTANDING VOLTAGE : 500 VAC/RMS

OPERATING TEMPERATURE

-25°C ~ + 85°C

101-00359-**

Double SIM + micro-SD P-P Combo



MATERIAL

HSG : HIGH TEMPERATURE THERMOPLASTIC
CONTACT : COPPER ALLOY
SHELL : COPPER ALLOY

RATING

CURRENT RATING : 0.5 A AC/DC Max
RATED VOLTAGE : 100 VAC

ELECTRICAL

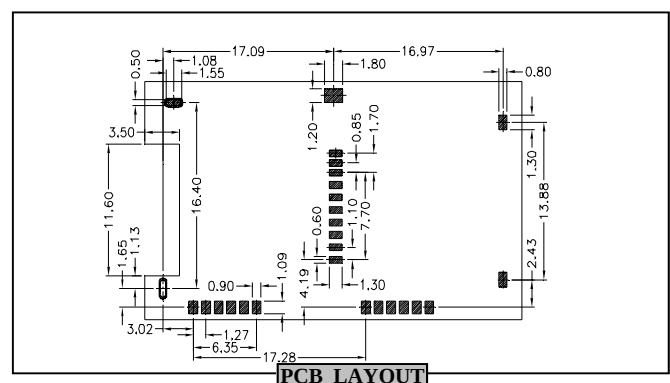
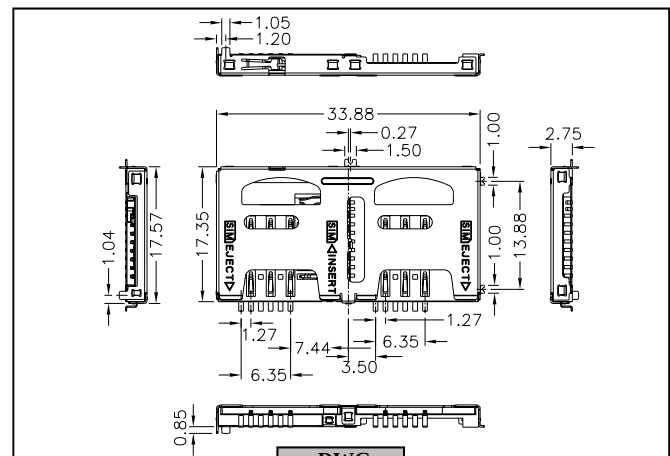
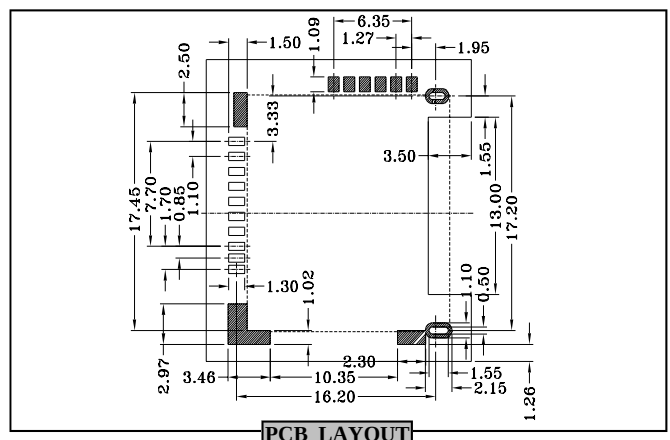
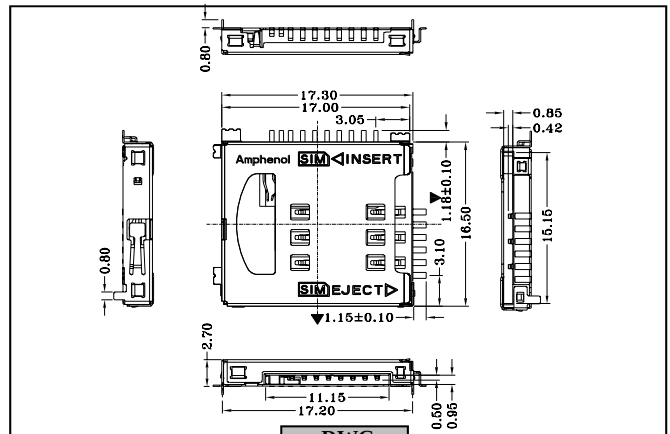
CONTACT RESISTANCE : 100 mΩ Max.
INSULATION RESISTANCE : 1000 MΩ Max.
DIELECTRIC WITHSTANDING VOLTAGE : 500 VAC/RMS

OPERATING TEMPERATURE

-25°C ~ + 85°C

Miniature Card Socket

SIM : Push in -Pull out
microSD: Push in - Push out



101-00492-**

Mega SIM + micro-SD Connector



MATERIAL

HSG : HIGH TEMPERATURE THERMOPLASTIC
CONTACT : COPPER ALLOY
SHELL : STAINLESS

RATING

CURRENT RATING : 0.5 A AC/DC Max
RATED VOLTAGE : 100 VAC

ELECTRICAL

CONTACT RESISTANCE : 100 mΩ Max.
INSULATION RESISTANCE : 1000 MΩ Max.
DIELECTRIC WITHSTANDING VOLTAGE : 500 VAC/RMS

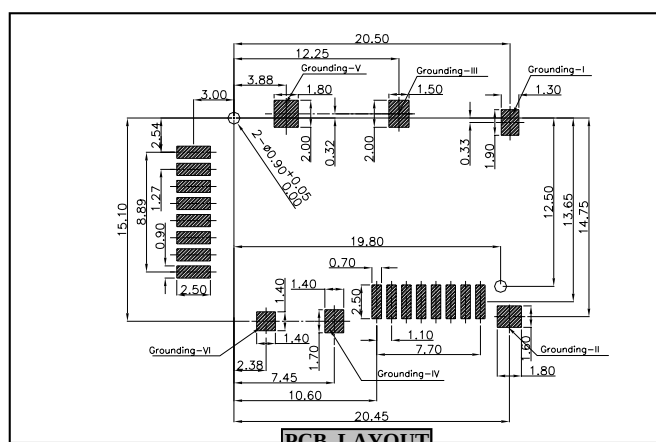
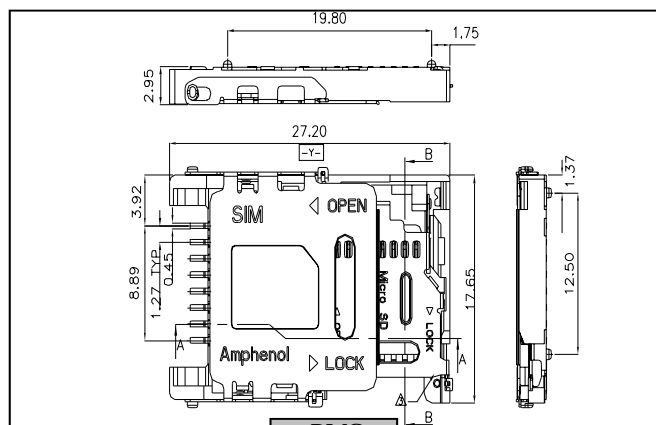
OPERATING TEMPERATURE

-25°C ~ + 85°C

Miniature Card Socket

SIM : Push in -Pull out

microSD: Push in - Push out



101-00269-**

SIM Socket, Normal Type



MATERIAL

HSG : HIGH TEMPERATURE THERMOPLASTIC
CONTACT : COPPER ALLOY
SHELL : STAINLESS STEEL

RATING

CURRENT RATING : 0.5 A AC/DC Max
RATED VOLT-AGE : 250 VAC 5.0 vrms

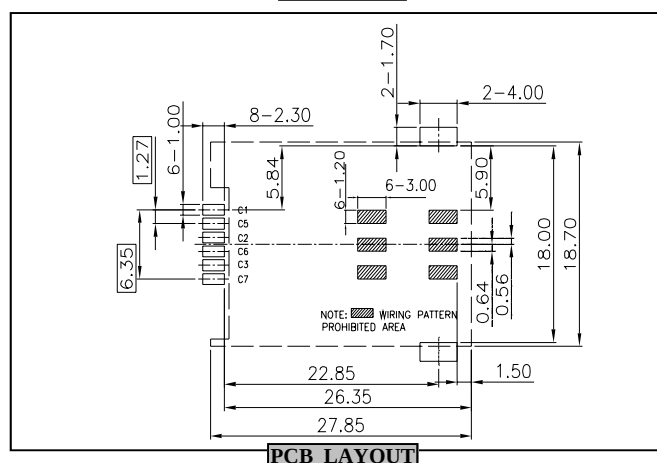
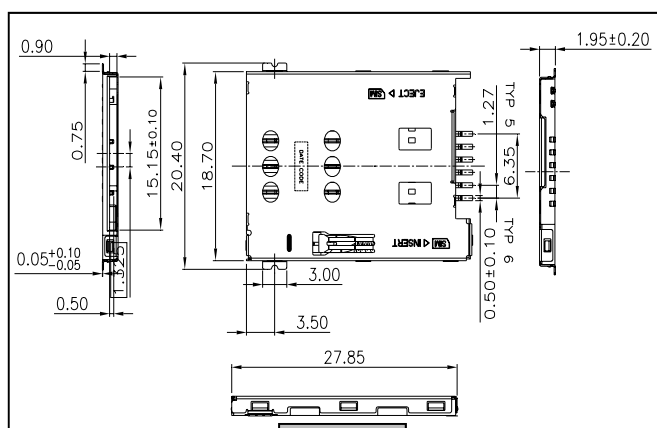
ELECTRICAL

CONTACT RESISTANCE : 100 mΩ Max.
INSULATION RESISTANCE : 1000 MΩ Max.
DIELECTRIC WITHSTANDING VOLTAGE : 250 VAC/RMS

OPERATING TEMPERATURE

-55°C ~ + 85°C

Push in-Pull out



101-00270-**

SIM Socket, Reverse Type

MATERIAL

HSG : HIGH TEMPERATURE THERMOPLASTIC
CONTACT : COPPER ALLOY
SHELL : STAINLESS STEEL

RATING

CURRENT RATING : 0.5 A AC/DC Max
RATED VOLT- 5.0 vrms

ELECTRICAL

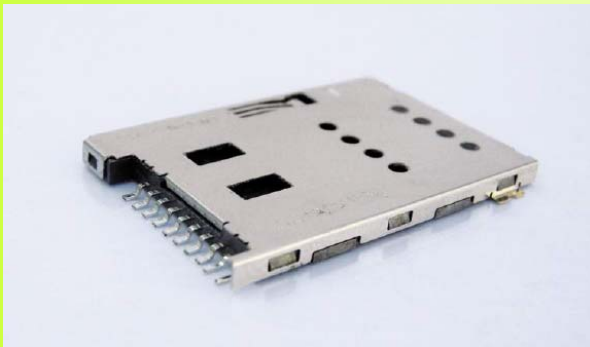
CONTACT RESISTANCE : 100 mΩ Max.
INSULATION RESISTANCE : 1000 MΩ Max.
DIELECTRIC WITHSTANDING VOLTAGE : 250 VAC/RMS

OPERATING TEMPERATURE

-55°C ~ +85°C

101-00271-**

Mega SIM Socket, Normal Type



MATERIAL

HSG : HIGH TEMPERATURE THERMOPLASTIC
CONTACT : COPPER ALLOY
SHELL : STAINLESS STEEL

RATING

CURRENT RATING : 0.5 A AC/DC Max
RATED VOLT- 5.0 vrms
AGE : 250 VAC

ELECTRICAL

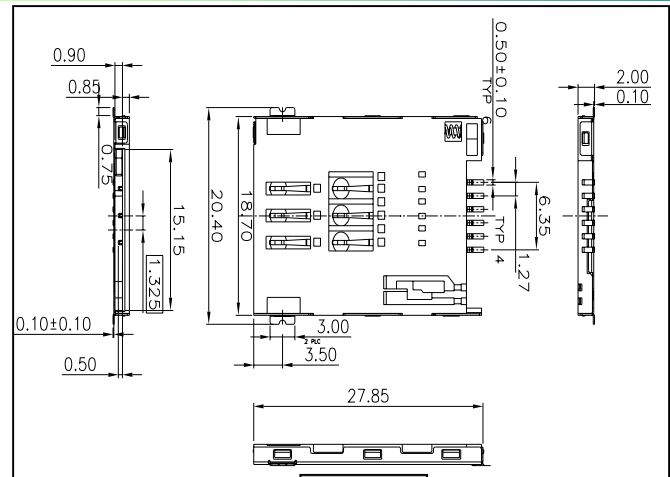
CONTACT RESISTANCE : 100 mΩ Max.
INSULATION RESISTANCE : 1000 MΩ Max.
DIELECTRIC WITHSTANDING VOLTAGE : 250 VAC/RMS

OPERATING TEMPERATURE

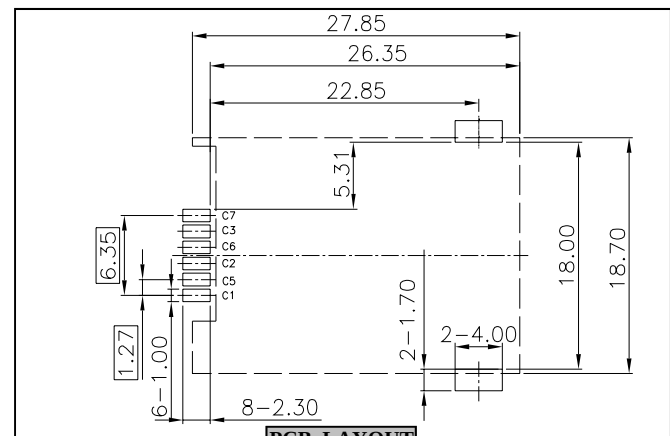
-55°C ~ +85°C

Miniature Card Socket

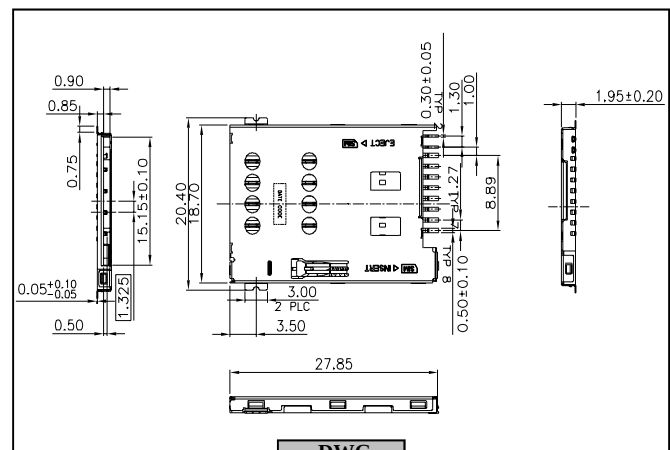
Push in-Pull out



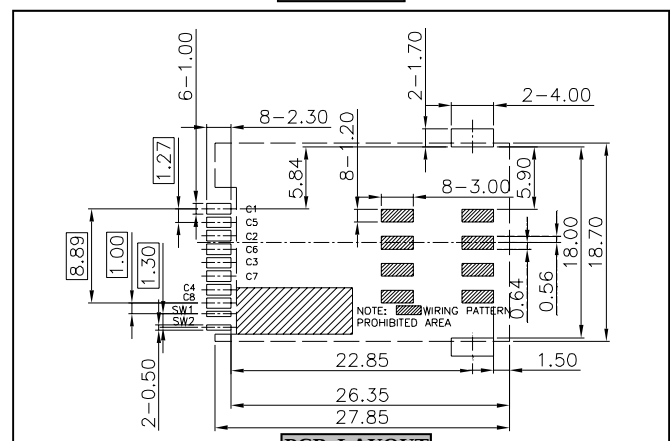
DWG



PCB LAYOUT



DWG



PCB LAYOUT

Miniature Card Socket

101-00272-**

Mega SIM Socket, Reverse Type



MATERIAL

HSG : HIGH TEMPERATURE THERMOPLASTIC
CONTACT : COPPER ALLOY
SHELL : STAINLESS STEEL

RATING

CURRENT RATING : 0.5 A AC/DC Max
RATED VOLT- 5.0 vrms

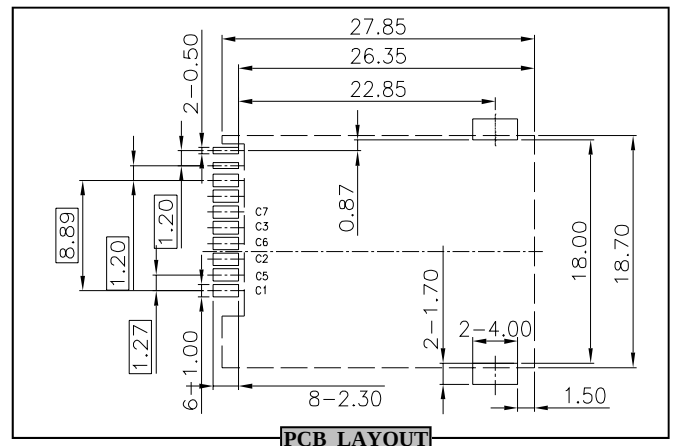
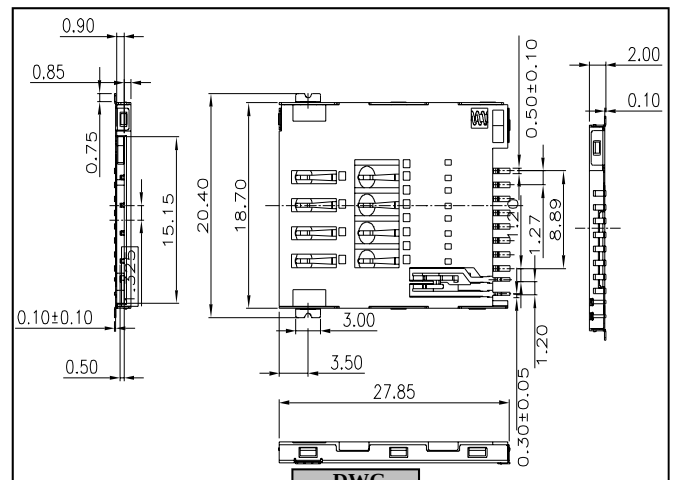
ELECTRICAL

CONTACT RESISTANCE : 100 mΩ Max.
INSULATION RESISTANCE : 1000 MΩ Max.
DIELECTRIC WITHSTANDING VOLTAGE : 250 VAC/RMS

OPERATING TEMPERATURE

-55°C ~ + 85°C

Push in-Pull out



101-00306-**

SIM Socket, Normal Type , W/ Switch (6 pin)



MATERIAL

HSG : HIGH TEMPERATURE THERMOPLASTIC
CONTACT : COPPER ALLOY
SHELL : STAINLESS STEEL

RATING

CURRENT RATING : 0.5 A AC/DC Max
RATED VOLT- 5.0 vrms
AGE : 250 VAC

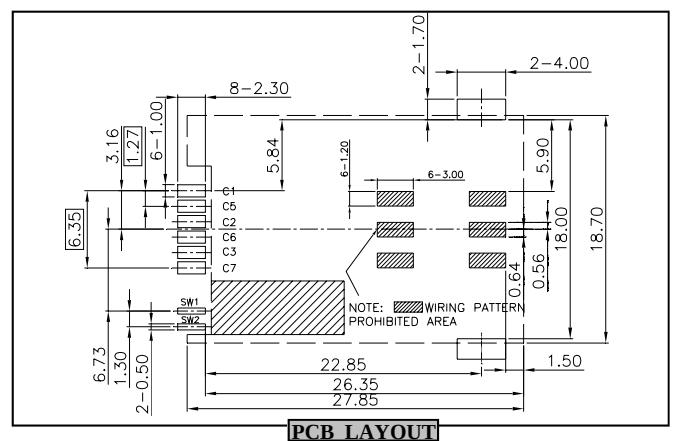
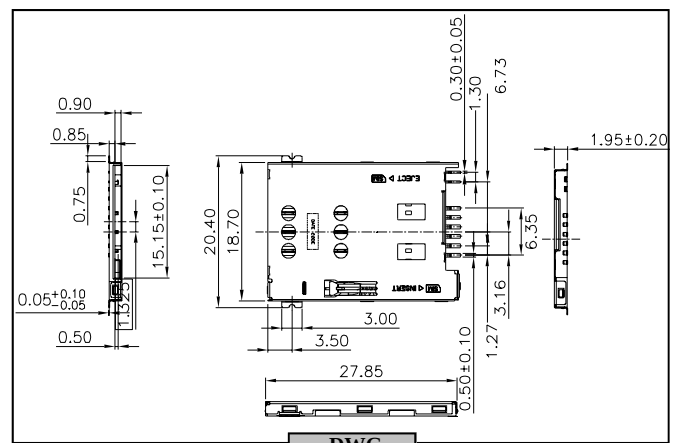
ELECTRICAL

CONTACT RESISTANCE : 100 mΩ Max.
INSULATION RESISTANCE : 1000 MΩ Max.
DIELECTRIC WITHSTANDING VOLTAGE : 250 VAC/RMS

OPERATING TEMPERATURE

-55°C ~ + 85°C

Push in-Push out



101-00309-**

Mega SIM Socket, Normal Type

MATERIAL

HSG : HIGH TEMPERATURE THERMOPLASTIC
CONTACT : COPPER ALLOY
SHELL : STAINLESS STEEL

RATING

CURRENT RATING : 0.5 A AC/DC Max
RATED VOLT- 5.0 vrms

ELECTRICAL

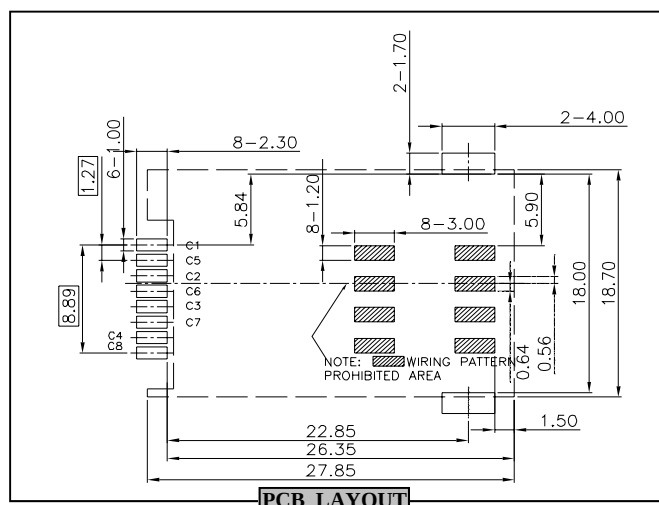
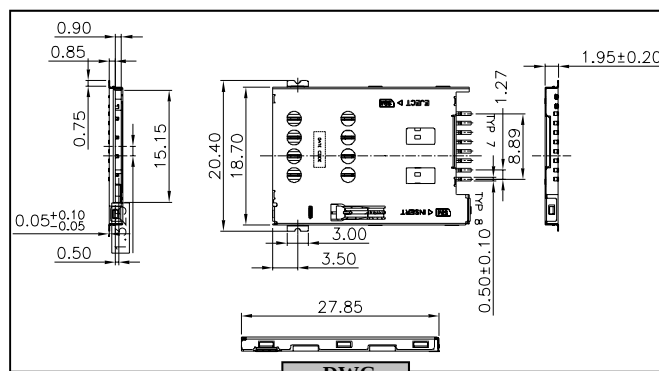
CONTACT RESISTANCE : 100 mΩ Max.
INSULATION RESISTANCE : 1000 MΩ Max.
DIELECTRIC WITHSTANDING VOLTAGE : 250 VAC/RMS

OPERATING TEMPERATURE

-55°C ~ +85°C

Miniature Card Socket

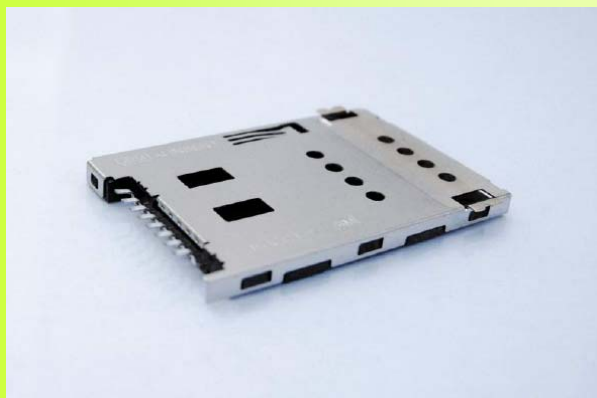
Push in-Pull out



101-00364-**

Mega SIM Socket, Normal Type

Push in-Pull out



MATERIAL

HSG : HIGH TEMPERATURE THERMOPLASTIC
CONTACT : COPPER ALLOY
SHELL : STAINLESS STEEL

RATING

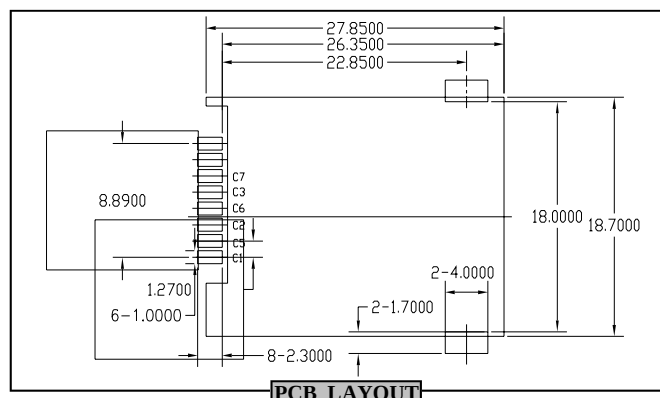
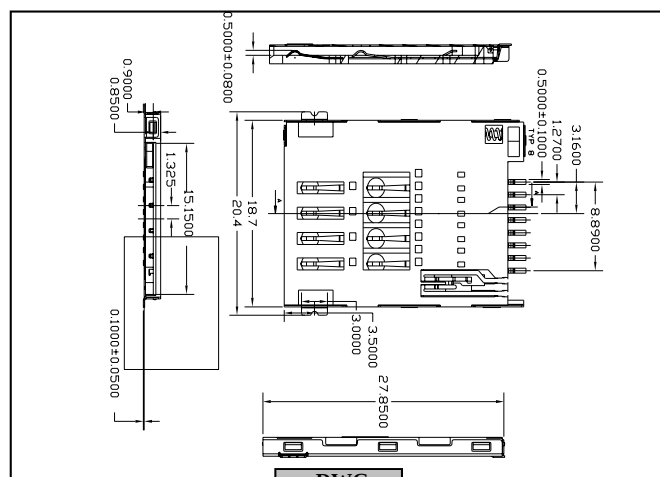
CURRENT RATING : 0.5 A AC/DC Max
RATED VOLT- 5.0 vrms
AGE : 250 VAC

ELECTRICAL

CONTACT RESISTANCE : 100 mΩ Max.
INSULATION RESISTANCE : 1000 MΩ Max.
DIELECTRIC WITHSTANDING VOLTAGE : 250 VAC/RMS

OPERATING TEMPERATURE

-55°C ~ +85°C



Miniature Card Socket

101-00365-**

SIM Socket, Reverse Type



MATERIAL

HSG : HIGH TEMPERATURE THERMOPLASTIC
CONTACT : COPPER ALLOY
SHELL : STAINLESS STEEL

RATING

CURRENT RATING : 0.5 A AC/DC Max
RATED VOLT-AGE : 250 VAC 5.0 vrms

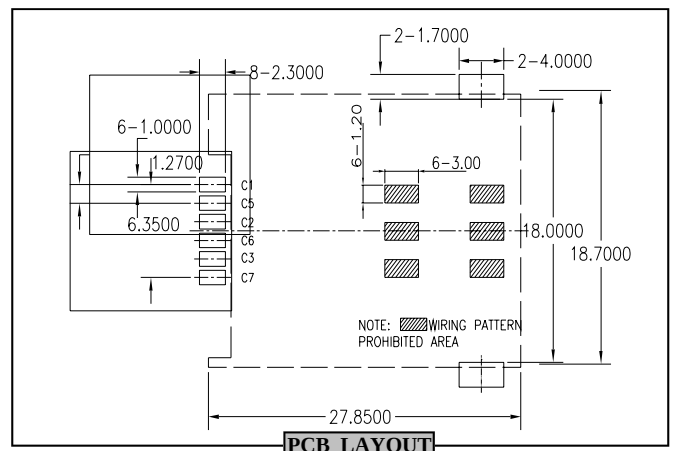
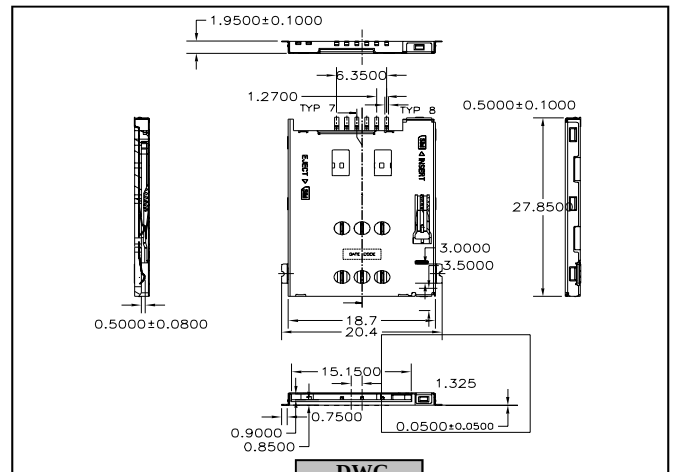
ELECTRICAL

CONTACT RESISTANCE : 100 mΩ Max.
INSULATION RESISTANCE : 1000 MΩ Max.
DIELECTRIC WITHSTANDING VOLTAGE : 250 VAC/RMS

OPERATING TEMPERATURE

-55°C ~ +85°C

Push in-Push out



101-00586-**

SIM Socket, Normal Type(H=2.4mm)



MATERIAL

HSG : HIGH TEMPERATURE THERMOPLASTIC
CONTACT : COPPER ALLOY
SHELL : STAINLESS STEEL

RATING

CURRENT RATING : 0.5 A AC/DC Max
RATED VOLT-AGE : 250 VAC 5.0 vrms

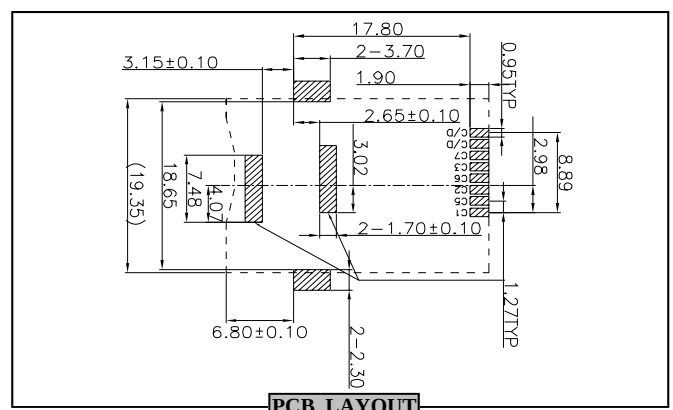
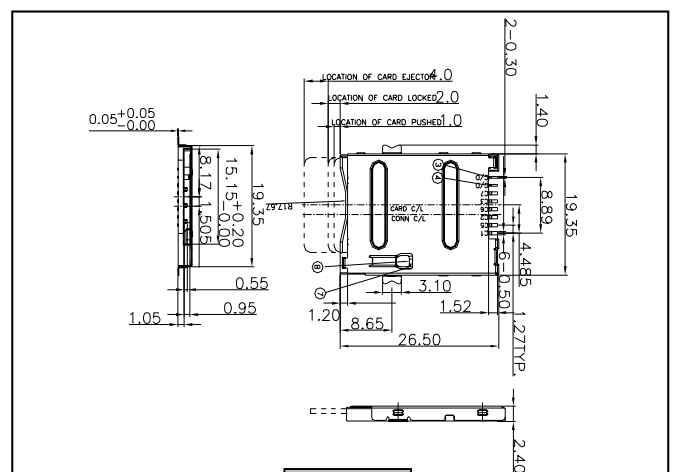
ELECTRICAL

CONTACT RESISTANCE : 100 mΩ Max.
INSULATION RESISTANCE : 1000 MΩ Max.
DIELECTRIC WITHSTANDING VOLTAGE : 250 VAC/RMS

OPERATING TEMPERATURE

-55°C ~ +85°C

Push in-Push out



Adapter Socket

106-00069-**

Mini-SD to SD Adapter



MATERIAL

HSG : HIGH TEMPERATURE THERMOPLASTIC
CONTACT : COPPER ALLOY

RATING

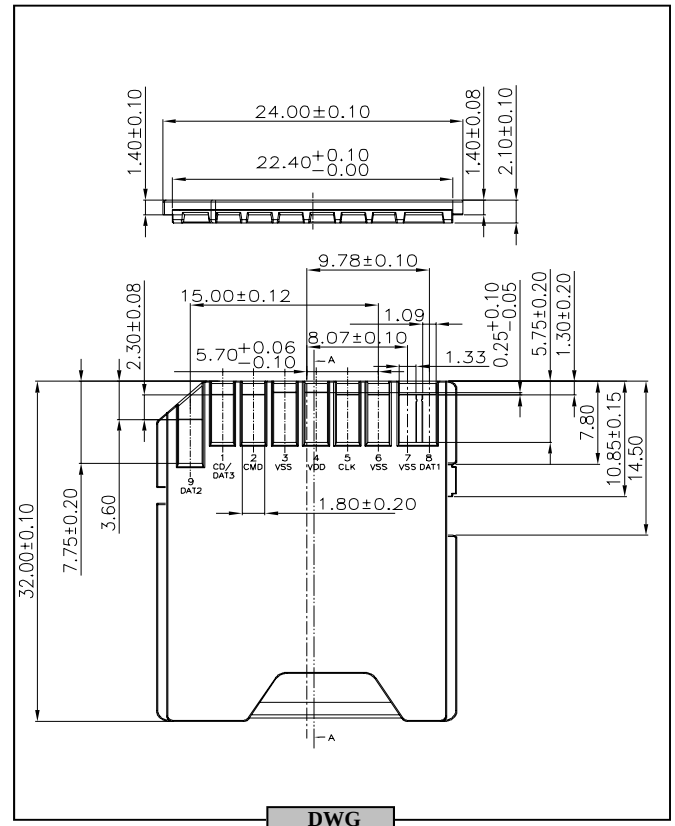
CURRENT RATING : 1 A AC/DC Max
RATED VOLTAGE : 500 V RMS Min.

ELECTRICAL

CONTACT RESISTANCE : 100 mΩ Max.
INSULATION RESISTANCE : 1000 MΩ Max.
DIELECTRIC WITHSTANDING VOLTAGE : 500 VAC/RMS

OPERATING TEMPERATURE

-25°C ~ + 85°C



106-00120-**

Mini-SD to SD Adapter



MATERIAL

HSG : HIGH TEMPERATURE THERMOPLASTIC
CONTACT : COPPER ALLOY

RATING

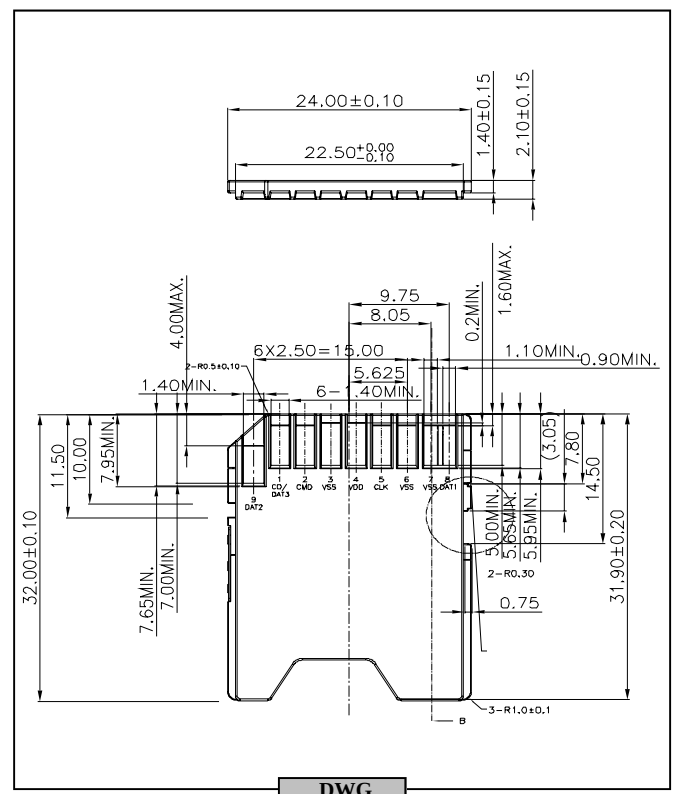
CURRENT RATING : 1 A AC/DC Max
RATED VOLT- 500 V RMS Min.

ELECTRICAL

CONTACT RESISTANCE : 100 mΩ Max.
INSULATION RESISTANCE : 1000 MΩ Max.
DIELECTRIC WITHSTANDING VOLTAGE : 500 VAC/RMS

OPERATING TEMPERATURE

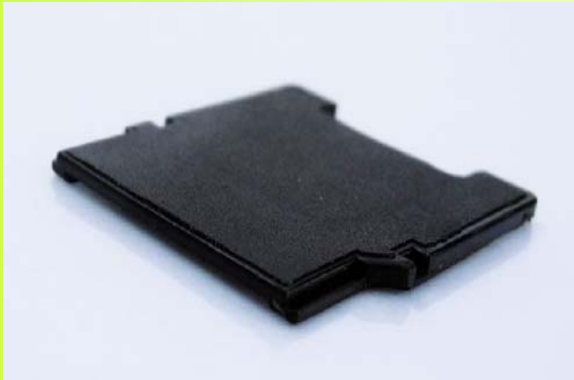
-25°C ~ + 85°C



Adapter Socket

106-00330

Micro-SD to mini-SD Adapter



MATERIAL

HSG : HIGH TEMPERATURE THERMOPLASTIC
CONTACT : COPPER ALLOY

RATING

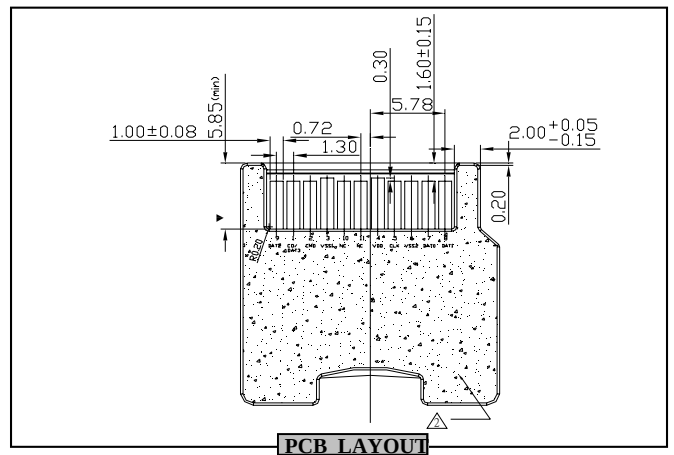
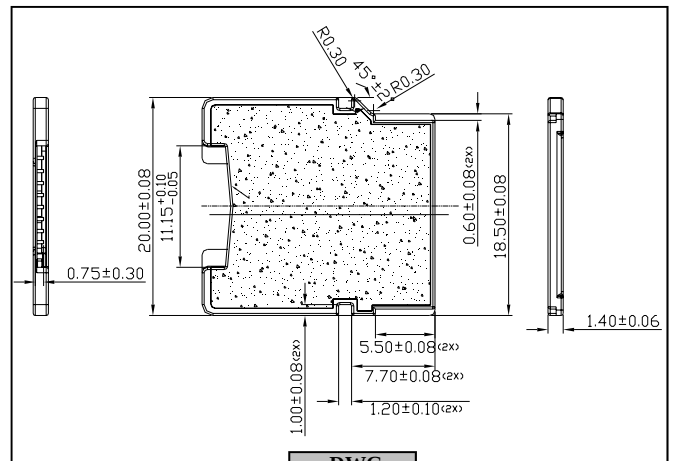
CURRENT RATING : 1 A AC/DC Max
RATED VOLT- 500 V RMS Min.

ELECTRICAL

CONTACT RESISTANCE : 100 mΩ Max.
INSULATION RESISTANCE : 1000 MΩ Max.
DIELECTRIC WITHSTANDING VOLTAGE : 500 VAC/RMS

OPERATING TEMPERATURE

-25°C ~ + 85°C



106-00351

Micro-SD to SD Adapter



MATERIAL

HSG : HIGH TEMPERATURE THERMOPLASTIC
CONTACT : COPPER ALLOY

RATING

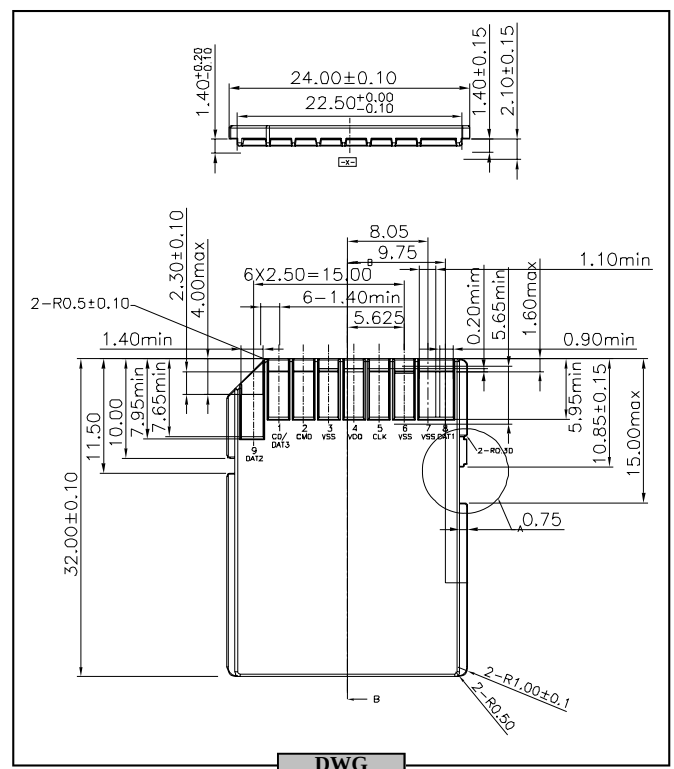
CURRENT RATING : 1 A AC/DC Max
RATED VOLTAGE : 500 V RMS Min.

ELECTRICAL

CONTACT RESISTANCE : 100 mΩ Max.
INSULATION RESISTANCE : 1000 MΩ Max.
DIELECTRIC WITHSTANDING VOLTAGE : 500 VAC/RMS

OPERATING TEMPERATURE

-25°C ~ + 85°C



105-00321-**

Mini-USB



MATERIAL

HSG : HIGH TEMPERATURE THERMOPLASTIC
CONTACT : COPPER ALLOY
SHELL : COPPER ALLOY

RATING

CURRENT RATING : 1.5 A mp
RATED VOLT-AGE : 50 VAC

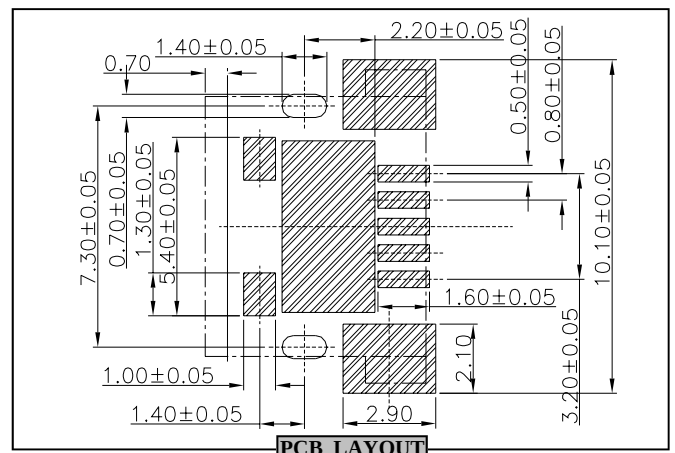
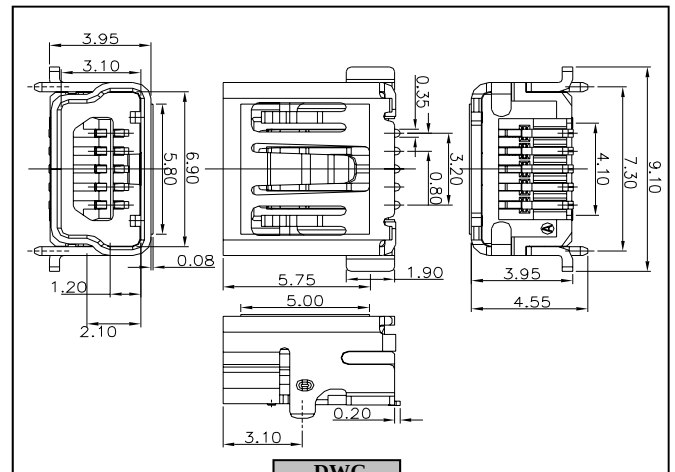
ELECTRICAL

CONTACT RESISTANCE : 50 mΩ Max.
INSULATION RESISTANCE : 1000 MΩ Max.
DIELECTRIC WITHSTANDING VOLTAGE : 500 VAC/RMS

OPERATING TEMPERATURE

-40°C ~ +85°C

Ultra Short Type



105-00569-**

Micro-USB



MATERIAL

HSG : HIGH TEMPERATURE THERMOPLASTIC
CONTACT : COPPER ALLOY
SHELL : COPPER ALLOY

RATING

CURRENT RATING : 1.5 A mp
RATED VOLT- 50 VAC

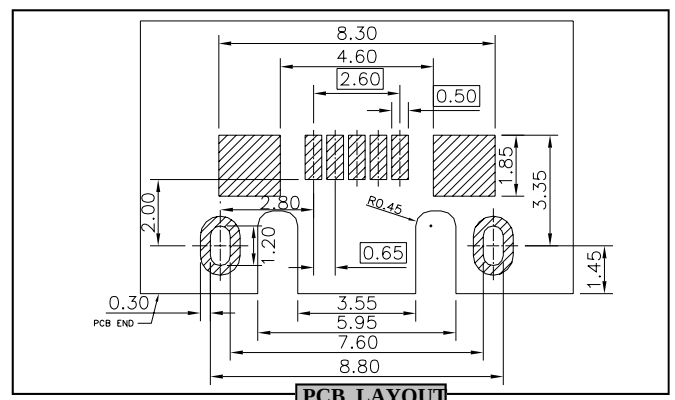
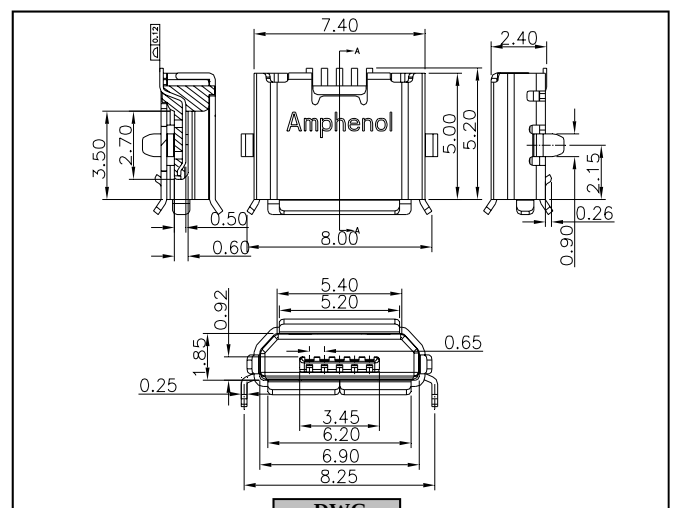
ELECTRICAL

CONTACT RESISTANCE : 30 mΩ Max.
INSULATION RESISTANCE : 1000 MΩ Max.
DIELECTRIC WITHSTANDING VOLTAGE : 500 VAC/RMS

OPERATING TEMPERATURE

-30°C ~ +85°C

Reverse Type



Mini Express Conn.

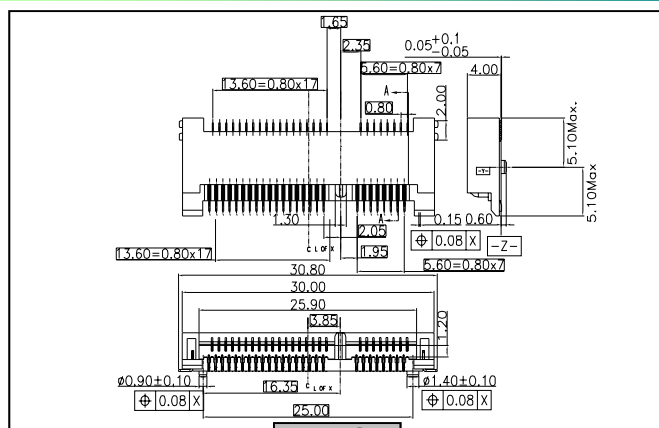
MATERIAL

RATING

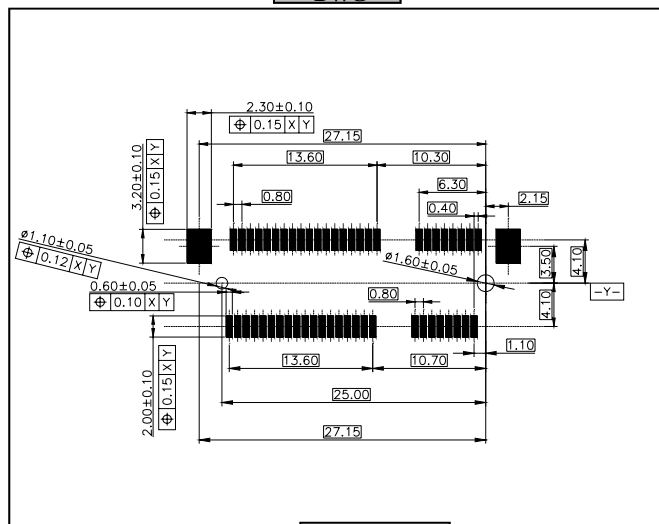
ELECTRICAL

OPERATING TEMPERATURE

-55°C ~ + 105°C



DWG



PCB LAYOUT

Wafer Series 3.5 / 4.0 / 13.0

SMT / DIP Type

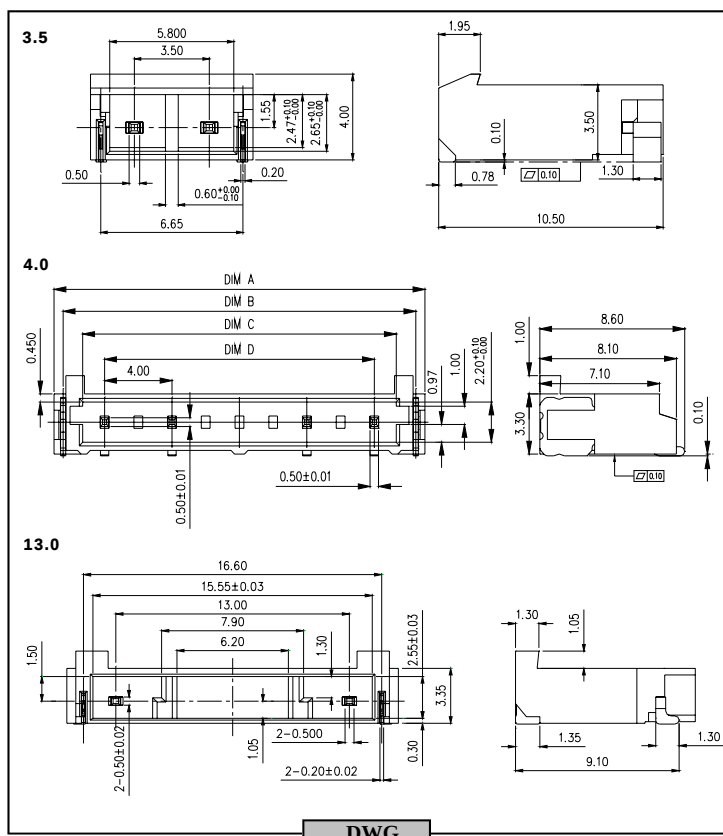
MATERIAL

RATING

ELECTRICAL

OPERATING TEMPERATURE

-55°C ~ + 105°C



DWG